

STV270N4F3

N-channel 40 V, 1.25 mΩ, 270 A, PowerSO-10 STripFET™ Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D ⁽¹⁾
STV270N4F3	40 V	$<$ 1.5 m Ω	270 A

- 1. Current limited by package
- Conduction losses reduced
- Low profile, very low parasitic inductance

Applications

Switching application

Description

This n-channel enhancement mode Power MOSFET is the latest refinement of STMicroelectronics' unique "single feature size" strip-based process, which has decreased the critical alignment steps, offering remarkable manufacturing reproducibility. The outcome is a transistor with extremely high packing density for low on resistance, rugged avalanche characteristics and low gate charge.

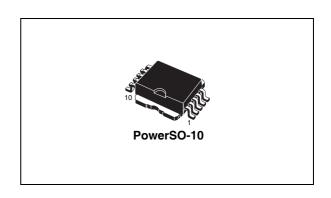


Figure 1. Internal schematic diagram and connection diagram (top view)

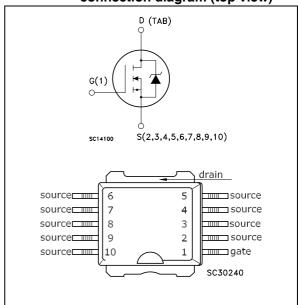


Table 1. Device summary

Order code	Marking	Package	Packaging
STV270N4F3	270N4F3	PowerSO-10	Tape and reel

Contents STV270N4F3

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STV270N4F3 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{DS}	Drain-source voltage (v _{gs} = 0)	40	V	
V _{GS}	Gate-source voltage	± 20	٧	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	270	Α	
I _D	Drain current (continuous) at T _C = 100 °C	220	Α	
I _{DM} ⁽¹⁾	Drain current (pulsed)	1080	Α	
P _{TOT} ⁽²⁾	Total dissipation at T _C = 25 °C	300	W	
	Derating factor	2	W/°C	
E _{AS} (3)	Single pulse avalanche energy	1000	mJ	
T _{stg}	Storage temperature	55 to 175	°C	
T _j	Operating junction temperature	-55 to 175		

^{1.} Current limited by package

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.5	°C/W
R _{thj-pcb} (1)	Thermal resistance junction-pcb max	50	°C/W

^{1.} When mounted on 1 inch2 FR-4 2 oz Cu.

^{2.} This value is rated according to Rthj-c

^{3.} Starting Tj = 25 °C, I_D = 80 A, V_{DD} = 32 V

Electrical characteristics STV270N4F3

2 Electrical characteristics

(Tcase =25°C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	40			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating, V_{DS} = Max rating, T_c =125 °C			10 100	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{DS} = ± 20 V			±200	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	V
R _{DS(on)}	Static drain-source on resistance	V_{GS} = 10 V, I_{D} = 80 A		1.25	1.5	mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 10 V _, I _D = 100 A		200		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz, V}_{GS} = 0$		7500 1900 50		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V _{DD} = 20 V, I _D = 160 A, V _{GS} = 10 V (see Figure 14)		110 30 25	150	nC nC nC

^{1.} Pulsed: Pulse duration = 300 µs, duty cycle 1.5%

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t _{d(on)} t _r	Turn-on delay time Rise time	V_{DD} = 20 V, I_D = 80 A R_G = 4.7 Ω , V_{GS} = 10 V (see Figure 13)		25 180		ns ns
t _{d(off)}	Turn-off delay time Fall time	V_{DD} = 20 V, I_D = 80 A R_G = 4.7 Ω , V_{GS} = 10 V, (see Figure 13)		110 45		ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				270 1080	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 80 A, V _{GS} = 0			1.3	٧
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 160 A,di/dt = 100 A/µs V_{DD} = 32 V, T_j = 150 °C (see Figure 15)		70 225 3.2		ns nC A

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STV270N4F3

2.1 Electrical characteristics

Figure 2. Safe operating area

Figure 3. Thermal impedance

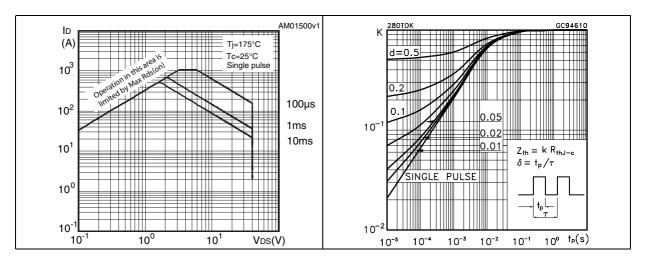


Figure 4. Output characteristics

Figure 5. Transfer characteristics

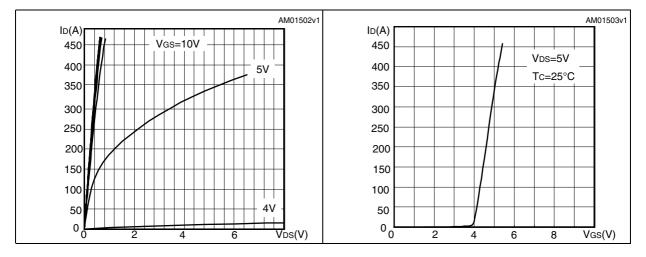
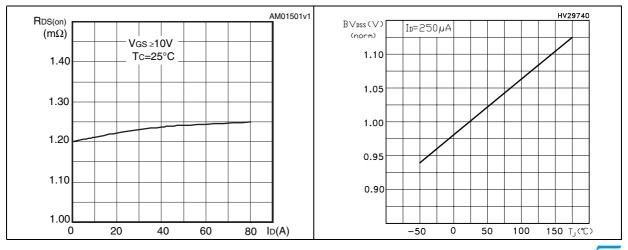


Figure 6. Static drain-source on resistance

Figure 7. Normalized B_{VDSS} vs temperature



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Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

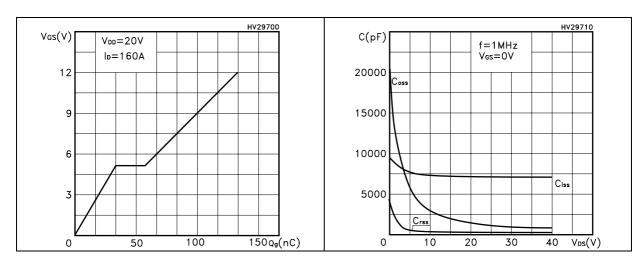


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on resistance vs temperature

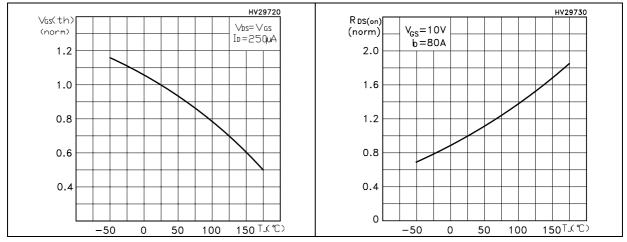
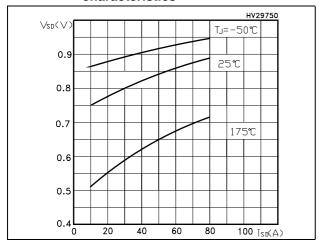


Figure 12. Source-drain diode forward characteristics



Test circuits STV270N4F3

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

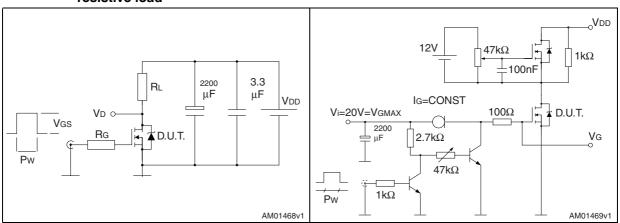


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

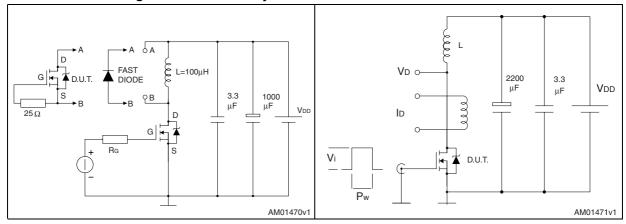
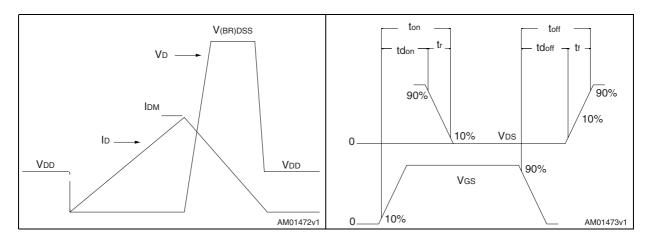


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform

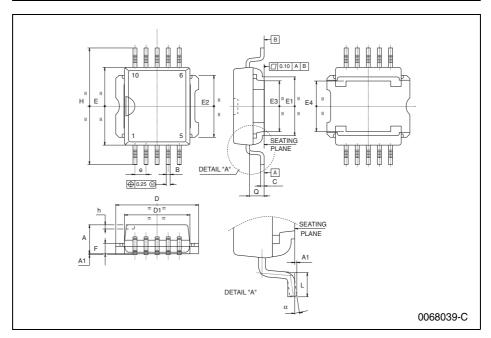


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

PowerSO-	.10	MECH		CAL	$D\Delta T$	ГΔ
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DIM.		mm				
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	3.35		3.65	0.132		0.144
A1	0.00		0.10	0.000		0.004
В	0.40		0.60	0.016		0.024
С	0.35		0.55	0.013		0.022
D	9.40		9.60	0.370		0.378
D1	7.40		7.60	0.291		0.300
е		1.27			0.050	
Е	9.30		9.50	0.366		0.374
E1	7.20		7.40	0.283		0.291
E2	7.20		7.60	0.283		0.300
E3	6.10		6.35	0.240		0.250
E4	5.90		6.10	0.232		0.240
F	1.25		1.35	0.049		0.053
h		0.50			0.002	
Н	13.80		14.40	0.543		0.567
L	1.20		1.80	0.047		0.071
q		1.70			0.067	
α	0°		8°			



STV270N4F3 Revision history

5 Revision history

Table 8. Document revision history

Date	Revision	Changes
25-Oct-2007	1	initial release
03-Apr-2008 2 I _D value has been updated.		I _D value has been updated.
01-Oct-2008	3	Document status promoted from preliminary data to datasheet

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